

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Date: July 26, 2006

Etsuro Morita, Akihiko Endo

Filed: July 26, 2006

Our Docket: SHX 373

For: METHOD FOR MANUFACTURING SOI WAFER

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §§ 1.56, 1.97, and 1.98

Applicants are submitting this Information Disclosure Statement pursuant to 37 C.F.R. §§ 1.56, 1.97, and 1.98 to disclose to the U.S. Patent and Trademark Office the patents, publications, applications, and/or other references listed on the enclosed, completed PTO-1449 form(s). The filing of this Information Disclosure Statement should not be construed as a representation that a search has been made or as an admission that the listed references are prior art for this application. Applicants respectfully request that the listed references be expressly considered during prosecution of the application, and that the references be made of record therein and appear among the "references cited" on any patents issuing therefrom.

CONTENT OF DISCLOSURE

This Information Disclosure Statement includes (1) one page of PTO-1449 forms, and (2) a legible copy of each foreign and non-patent reference, if any, listed on the form(s). However, because this application was filed on or after July 1, 2003, no copies of U.S. patents or published U.S. patent applications are included.

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FOREIGN-LANGUAGE REFERENCES

A concise explanation of the relevance of each listed reference not in the English language is attached to each reference.

TIMING OF DISCLOSURE / FEE INFORMATION

This Information Disclosure Statement is being filed with the application or with a Request for Continued Examination of the application under 37 C.F.R. §1.114. Therefore, in accordance with 37 C.F.R. § 1.97(b), no fee or statement under 37 C.F.R. § 1.97(e) is required.

Please contact the undersigned with any questions or comments regarding this Information Disclosure Statement.

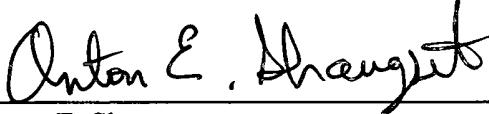
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I hereby certify that the attached correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.



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Respectfully submitted,
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SHEET 1 OF 1

| FORM PTO-1449 INFORMATION DISCLOSURE CITATION IN AN APPLICATION | | DOCKET NUMBER SHX 373 | APPLICATION NUMBER | | |
|---------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|-------------------------------|--------------------|--------------------------------------------|----------------------------|
| | | APPLICANT(S) Etsuro Morita | | | |
| | | FILING DATE July 26, 2006 | GROUP ART UNIT | | |
| U.S. PATENT DOCUMENTS | | | | | |
| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME | CLASS SUB CLASS FIL. DATE IF APPROP. | |
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| OTHER DOCUMENTS | | | | | |
| | International Search Report dated April 14, 2005 for International Application No. PCT/JP2005/001226. | | | | |
| EXAMINER | DATE CONSIDERED | | | | |